

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

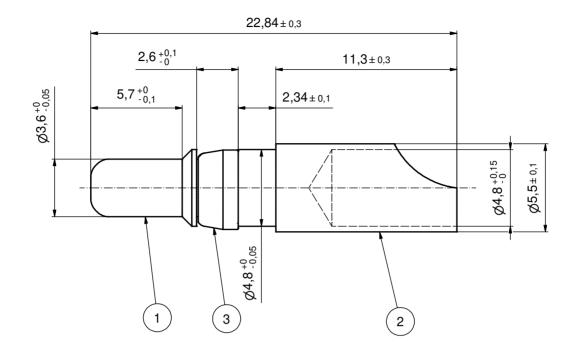
Email & Skype: info@chipsmall.com Web: www.chipsmall.com

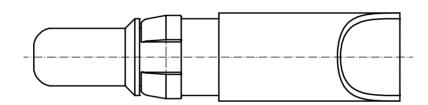
Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China

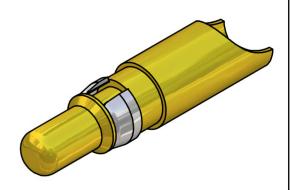












Directive 2002/95/EC "RoHS" Compliant

APPROVAL # FREIG	ABE # DEBLOCAGE # AUTORIZACION # APPROVAL	₽
CUSTOMER APPRO	OVAL DATE:	APPROVAL # FREIGABE #
NAME:	TITLE:	ABE# DEBLOCAC
COMPANY NAME:		DEBLOCAGE # AUTORIZA

b

PLATING ITEM 1	PART-NO.
30μin HARD GOLD over min. 50μin NICKEL	131C10049X
50uin HARD GOLD over min. 50uin NICKEL	131.I10049X

NOTES:

1. MATERIAL: COPPER ALLOY

2. PLATING:
ITEM 1: SEE TABLE
ITEM 2: min. 8µin HARD GOLD over 50µin NICKEL
ITEM 3: NICKEL PLATED

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